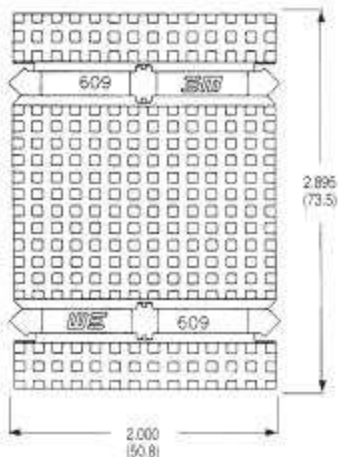


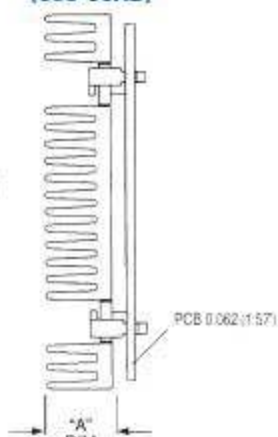
# wakefield-vette

| Standard P/N | Base Dimensions in. (mm)     | Dimensions "A" in. (mm) | Typical Applications | Heat Sink Finish | Weight lbs. (grams) |
|--------------|------------------------------|-------------------------|----------------------|------------------|---------------------|
| 609-50AB     | 2.895 (73.5) x 2.000 (50.8)  | 0.500 (12.7)            | 40&45mm BGA          | Black Anodized   | 0.094 (42.5)        |
| 609-100AB    | 2.808 (71.32) x 1.700 (43.2) | 1.00 (25.4)             | 40&45mm BGA          | Black Anodized   | 0.130 (59.0)        |

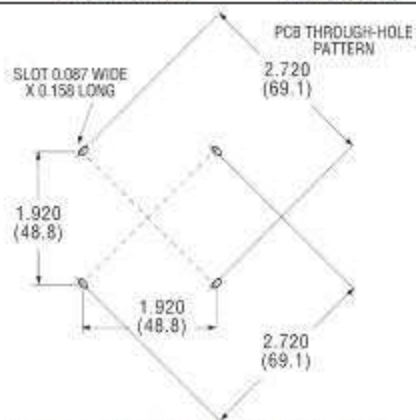
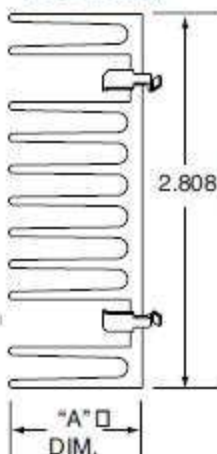
## MECHANICAL DIMENSIONS



**(609-50AB)**

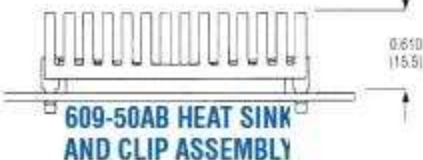


**(609-100AB)**

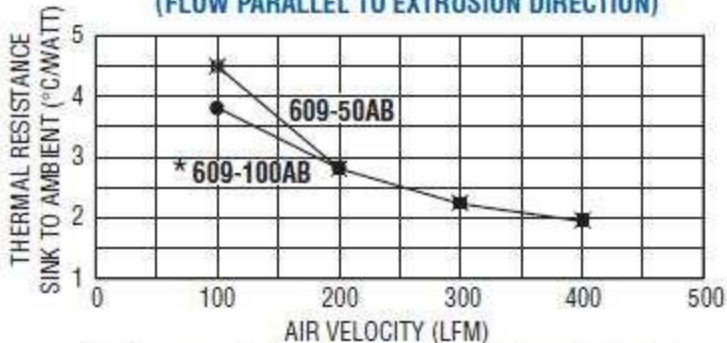


Designed to fit a .063" thick PCB electronic package thickness of .110"

Dimensions: in. (mm)



## FORCED CONVECTION THERMAL PERFORMANCE DATA (FLOW PARALLEL TO EXTRUSION DIRECTION)



\*Performance is for shrouded conditions. 609-100 will perform better than 609-50 in cases with bypass.